

**1.0A SURFACE MOUNT FAST RECOVERY RECTIFIER**

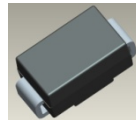
**Features**

- Glass Passivated Die Construction
- Fast Recovery Time for High Efficiency
- Surge Overload Rating to 30A Peak
- Ideally Suited for Automated Assembly
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

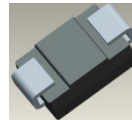
**Mechanical Data**

- Case: SMA/SMB
- Case Material: Molded Plastic.  
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Annealed over Copper Alloy Leadframe; Solderable per MIL-STD-202, Method 208<sup>(3)</sup>
- Polarity: Cathode Band or Cathode Notch
- Weight: SMA - 0.064 grams (Approximate)  
SMB - 0.093 grams (Approximate)

**SMA/SMB**



Top View



Bottom View

**Ordering Information** (Note 4)

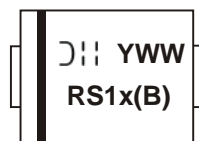
Part Number	Case	Packaging
RS1x-13-F	SMA	5000/Tape & Reel
RS1xB-13-F	SMB	3000/Tape & Reel

\* x = Device type, e.g. RS1D-13-F (SMA package); RS1JB-13-F (SMB package).

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

**Marking Information**

**SMA/SMB**



RS1x = Product Type Marking Code, ex: RS1G (SMA Package)  
 RS1xB = Product Type Marking Code, ex: RS1GB (SMB Package)  
 DII = Manufacturer's Code Marking  
 YWW = Date Code Marking  
 Y = Last Digit of Year (ex: 9 for 2019)  
 WW = Week Code (01 to 53)

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Characteristic	Symbol	RS1 A/AB	RS1 B/BB	RS1 D/DB	RS1 G/GB	RS1 J/JB	RS1 K/KB	RS1 M/MB	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>								
Working Peak Reverse Voltage	V <sub>RWM</sub>	50	100	200	400	600	800	1000	V
DC Blocking Voltage (Note 5)	V <sub>R</sub>								
RMS Reverse Voltage	V <sub>R(RMS)</sub>	35	70	140	280	420	560	700	V
Average Rectified Output Current @ T <sub>T</sub> = +120°C	I <sub>O</sub>	1.0							A
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	30							A

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Terminal (Note 6)	R <sub>θJT</sub>	20	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic	Symbol	RS1 A/AB	RS1 B/BB	RS1 D/DB	RS1 G/GB	RS1 J/JB	RS1 K/KB	RS1 M/MB	Unit
Minimum Reverse Breakdown Voltage (Note 5) @ I <sub>R</sub> = 5μA	V <sub>(BR)R</sub>	50	100	200	400	600	800	1000	V
Maximum Forward Voltage Drop @ I <sub>F</sub> = 1.0A	V <sub>FM</sub>	1.3							V
Peak Reverse Current @ T <sub>A</sub> = +25°C	I <sub>RM</sub>	5.0							μA
at Rated DC Blocking Voltage (Note 5) @ T <sub>A</sub> = +125°C		200							
Maximum Reverse Recovery Time (Note 7)	t <sub>RR</sub>	150				250	500		ns
Typical Total Capacitance (Note 8)	C <sub>T</sub>	15							pF

- Notes:
5. Short duration pulse test used to minimize self-heating effect.
  6. Valid provided that terminals are kept at ambient temperature.
  7. Reverse recovery test conditions: I<sub>F</sub> = 0.5A, I<sub>R</sub> = 1.0A, I<sub>RR</sub> = 0.25A. See Figure 5.
  8. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

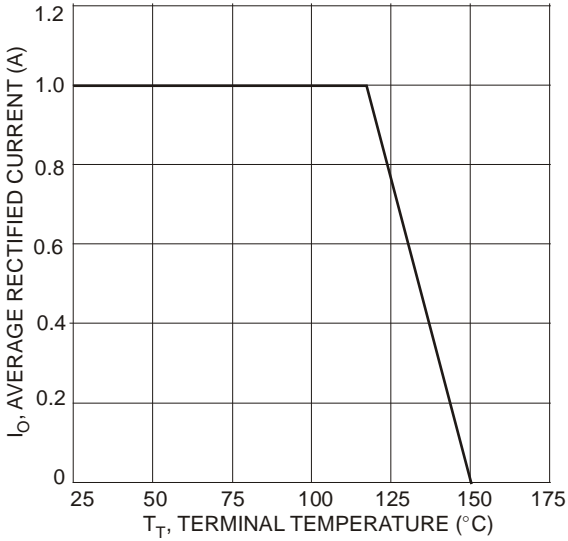


Fig. 1 Forward Current Derating Curve

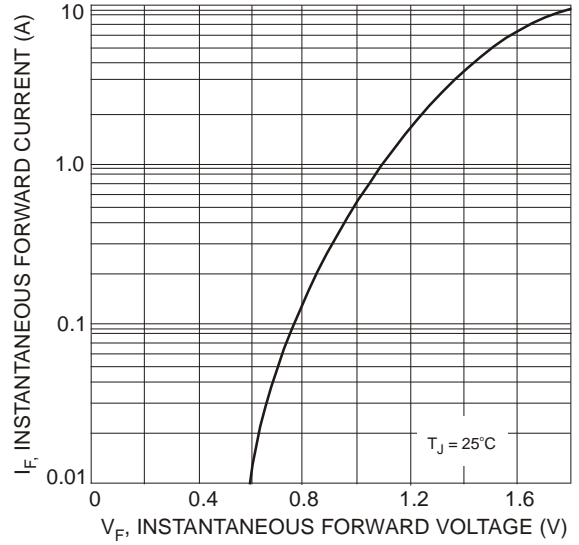


Fig. 2 Typical Forward Characteristics

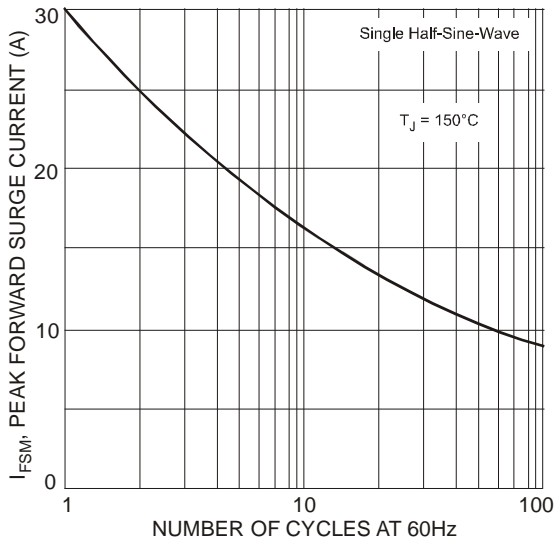


Fig. 3 Forward Surge Current Derating Curve

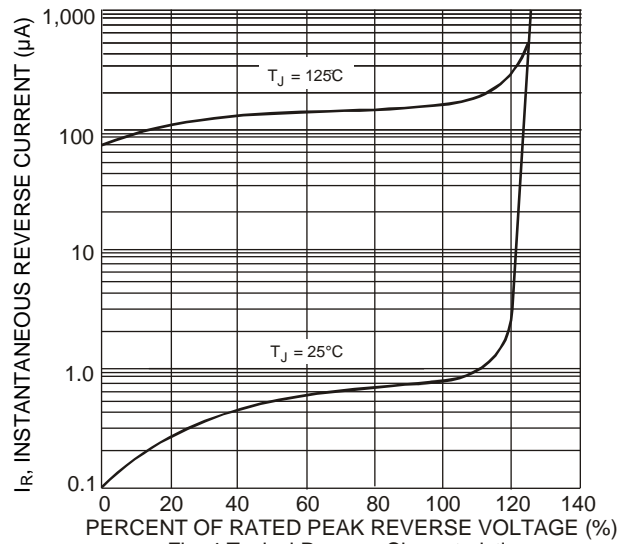
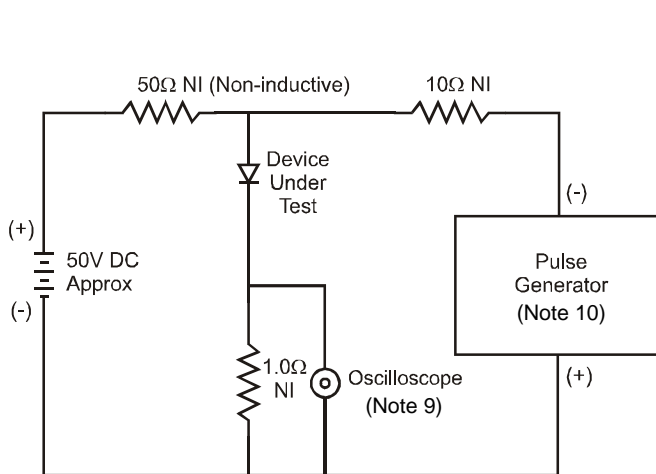
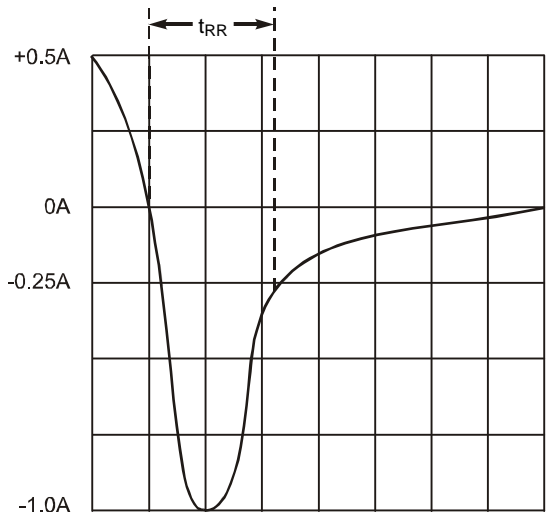


Fig. 4 Typical Reverse Characteristics



Notes:  
 9. Rise Time = 7.0ns max. Input Impedance = 1.0MΩ, 22pF.  
 10. Rise Time = 10ns max. Input Impedance = 50Ω.



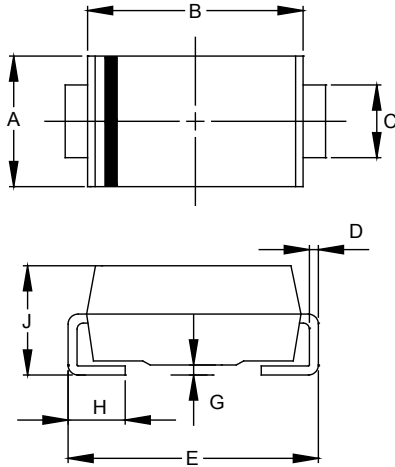
Set time base for 50/100 ns/cm

Fig. 5 Reverse Recovery Time Characteristic and Test Circuit

**Package Outline Dimensions**

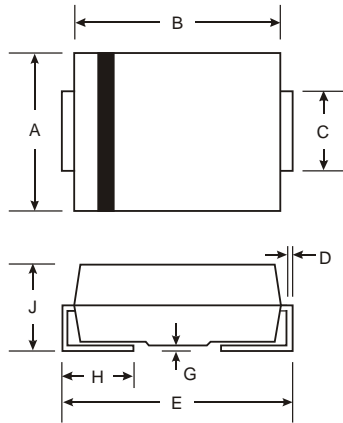
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SMA**



SMA		
Dim	Min	Max
A	2.29	2.92
B	4.00	4.60
C	1.27	1.63
D	0.15	0.31
E	4.80	5.59
G	0.05	0.20
H	0.76	1.52
J	1.96	2.40
All Dimensions in mm		

**SMB**

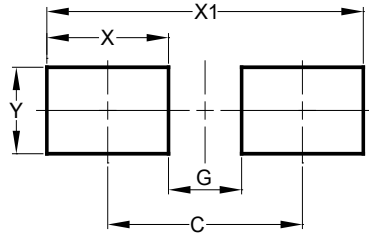


SMB		
Dim	Min	Max
A	3.30	3.94
B	4.06	4.57
C	1.96	2.21
D	0.15	0.31
E	5.00	5.59
G	0.05	0.20
H	0.76	1.52
J	2.00	2.50
All Dimensions in mm		

## Suggested Pad Layout

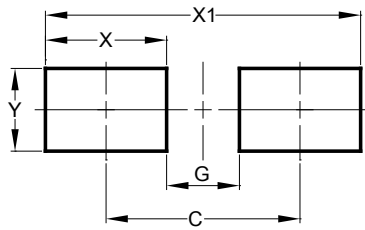
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### SMA



Dimensions	Value (in mm)
C	4.00
G	1.50
X	2.50
X1	6.50
Y	1.70

### SMB



Dimensions	Value (in mm)
C	4.30
G	1.80
X	2.50
X1	6.80
Y	2.30

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